

Description

The 0805 series provides miniature surface mount resettable Over-current protection with holding current from 0.05A to 1.50A. This series is suitable for ultraportable applications where space is at a premium and the device current is low.

Device Schematic



Ordering Information

Features

- * I(hold):0.05~1.50A
- Very high voltage surge capabilities
- * Available in lead-free version
- * Fast response to fault current
- * RoHS compliant, Lead-Free and Halogen-Free
- * Low resistance
- * Compact design saves board space
- * Compatible with high temperature solders

Applications

- USB peripherals
- * PDAs/digital cameras
- * Disk drives
- * Game console port protection
- * CD-ROMs
- * protection
- * General electronics
- * Plug and play protection for motherboards and peripherals
- * Disk drives
- * Set-top-box and HDMI
- Mobile Internet Device (M|D).
- * Mobile phones -battery and port protection

Model	Quantity
SMD0805P005TF~ SMD0805P050TF/24	5000PCS
SMD0805P050TF/12,075TF,075TF/12	4000PCS
SMD0805P100TF ~ SMD0805P150TF	3000PCS

SMD0805 Series



Performance Specification

Type Number	I _{hold}	I _{trip}	V _{max}	Ma Time t		I _{max}	P _{d typ}	Ri _{min}	R1 _{max}
	Α	A	V _{DC}	Current A	T _{max} S	Α	w	Ω	Ω
SMD0805P005TF	0.05	0.30	15	0.5	1.50	30	0.5	1.50	20
SMD0805P010TF	0.10	0.30	15	0.5	1.50	30	0.5	0.75	6
SMD0805P020TF	0.20	0.50	9	8	0.02	30	0.5	0.50	3.5
SMD0805P020TF/12	0.20	0.50	12	8	0.02	30	0.5	0.50	3.5
SMD0805P020TF/16	0.20	0.50	16	8	0.02	30	0.5	0.50	3.5
SMD0805P035TF	0.35	0.75	6	8	0.10	30	0.5	0.20	1.2
SMD0805P035TF/12	0.35	0.75	12	8	0.10	30	0.5	0.20	1.2
SMD0805P050TF	0.50	1.00	6	8	0.10	30	0.5	0.10	0.85
SMD0805P050TF/12	0.50	1.00	12	8	0.10	30	0.5	0.10	0.85
SMD0805P050TF/16	0.50	1.00	16	8	0.10	30	0.5	0.10	0.85
SMD0805P050TF/24	0.50	1.00	24	8	0.10	30	0.5	0.10	0.85
SMD0805P075TF	0.75	1.50	6	8	0.20	35	0.6	0.07	0.385
SMD0805P075TF/12	0.75	1.50	12	8	0.20	35	0.6	0.07	0.385
SMD0805P100TF	1.00	1.95	6	8	0.30	35	0.6	0.04	0.23
SMD0805P100TF/12	1.00	1.95	12	8	0.30	35	0.6	0.04	0.23
SMD0805P110TF	1.10	2.20	6	8	0.30	35	0.6	0.035	0.21
SMD0805P110TF/12	1.10	2.20	12	8	0.30	35	0.6	0.035	0.21
SMD0805P125TF	1.25	2.50	6	8	0.60	35	1.5	0.025	0.14
SMD0805P150TF	1.50	3.00	6	8	0.50	35	1.0	0.015	0.13

V_{max} = Maximum operating voltage device can withstand without damage at rated current (Imax).

Imax =Maximum fault current device can withstand without damage at rated voltage (V max).

I hold = Hold Current Maximum current device will not trip in 25C still air.

I trip = Trip Current Minimum current at which the device will always trip in 25C still air.

P d = Power dissipation when device is in the tripped state in 25C still air environment at rated voltage.

Ri min/max = Minimum/Maximum device resistance prior to tripping at 25° C.

R1 max = Maximum device resistance is measured one hour post reflow.

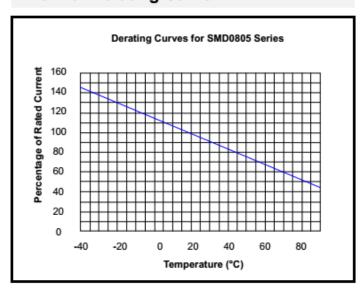
SMD0805 Series



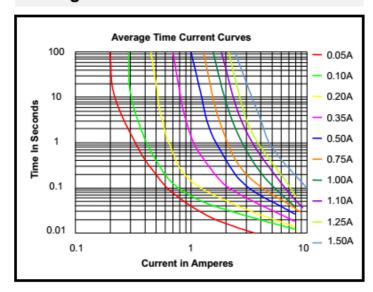
Themal Derating Chart-Ih (A)

Part Number				Ambient (Operation Te	mperature			
	-40 °C	-20 °C	0 ℃	25 °C	40 °C	50 °C	60 °C	70 °C	85 °C
SMD0805P005TF	0.07	0.06	0.055	0.05	0.04	0.035	0.03	0.025	0.015
SMD0805P010TF	0.14	0.12	0.11	0.1	0.08	0.07	0.06	0.05	0.03
SMD0805P020TF	0.28	0.25	0.23	0.20	0.17	0.14	0.12	0.10	0.07
SMD0805P020TF/12	0.28	0.25	0.23	0.20	0.17	0.14	0.12	0.10	0.07
SMD0805P020TF/16	0.28	0.25	0.23	0.20	0.17	0.14	0.12	0.10	0.07
SMD0805P035TF	0.47	0.44	0.39	0.35	0.30	0.27	0.24	0.20	0.14
SMD0805P035TF/12	0.47	0.44	0.39	0.35	0.30	0.27	0.24	0.20	0.14
SMD0805P050TF	0.68	0.62	0.55	0.50	0.40	0.37	0.33	0.29	0.23
SMD0805P050TF/12	0.68	0.62	0.55	0.50	0.40	0.37	0.33	0.29	0.23
SMD0805P050TF/16	0.68	0.62	0.55	0.50	0.40	0.37	0.33	0.29	0.23
SMD0805P050TF/24	0.68	0.62	0.55	0.50	0.40	0.37	0.33	0.29	0.23
SMD0805P075TF	1.00	0.90	0.79	0.75	0.63	0.57	0.53	0.41	0.34
SMD0805P075TF/12	1.00	0.90	0.79	0.75	0.63	0.57	0.53	0.41	0.34
SMD0805P100TF	1.35	1.25	1.15	1.00	0.82	0.74	0.65	0.55	0.42
SMD0805P100TF/12	1.35	1.25	1.15	1.00	0.82	0.74	0.65	0.55	0.42
SMD0805P110TF	1.45	1.35	1.20	1.10	0.92	0.84	0.75	0.65	0.52
SMD0805P110TF/12	1.45	1.35	1.20	1.10	0.92	0.84	0.75	0.65	0.52
SMD0805P125TF	1.65	1.53	1.36	1.25	1.05	0.95	0.85	0.74	0.59
SMD0805P150TF	1.98	1.84	1.63	1.50	1.26	1.14	1.02	0.88	0.71

Thermal Derating Curve

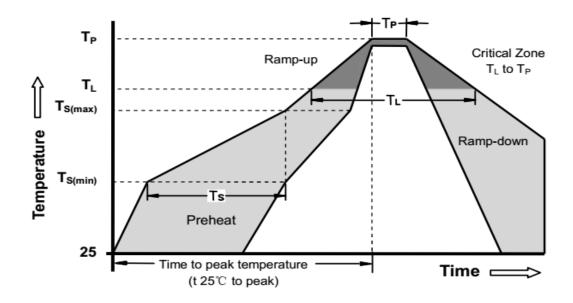


Average Time-Current Curve





Soldering Parameters

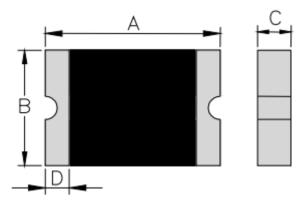


Reflow	Condition	Pb - Free assembly
	-Temperature Min (T _{s(min)})	150°C
Pre Heat	-Temperature Max (T _{s(max)})	200°C
	- Time (min to max) (t _s)	60 -180 Seconds
_	e ramp up rate (Liquids _) to peak	3°C/second max
T _{S(max)} to	TL - Ramp-up Rate	3°C/second max
Reflo	- Temperature (T _L) (Liquids)	217°C
w	- Time (min to max) (t _s)	60 -150 Seconds
Peak Te	mperature (T _P)	260 +0/-5°C
	thin 5°C of actual peak ature (t _p)	20 - 40 Seconds
Ramp-d	own Rate	6°C/second max
Time 25	°C to peak Temperature (T _P)	8 minutes Max
Do not e	exceed	260°C

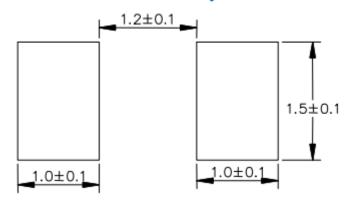


Positive Thermal Coefficient

Average Time Current (mm)



Recommended Pad Layout (mm)

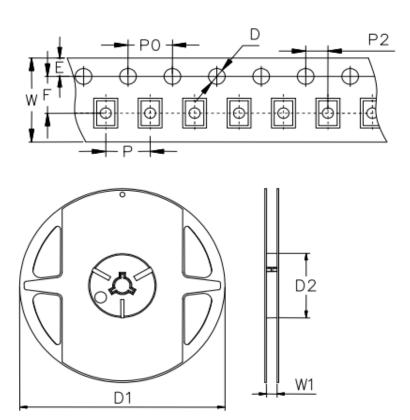


Dimensions

		P	ackage	Dimensi	ons (mr	n)				Packag	e Dimen	sions (i	n)	
Type Number	,	A	E	3	(С	D	,	Α.	ı	В	(:	D
	min	max	min	max	min	max	min	min	max	min	max	min	max	min
SMD0805P005TF	2	2.2	1.2	1.5	0.4	1.0	0.2	0.079	0.087	0.047	0.059	0.016	0.039	0.008
SMD0805P010TF	2	2.2	1.2	1.5	0.4	1.0	0.2	0.079	0.087	0.047	0.059	0.016	0.039	0.008
SMD0805P020TF	2	2.2	1.2	1.5	0.35	1.0	0.2	0.079	0.087	0.047	0.059	0.014	0.039	0.008
SMD0805P020TF/12	2	2.2	1.2	1.5	0.35	1.0	0.2	0.079	0.087	0.047	0.059	0.014	0.039	0.008
SMD0805P020TF/16	2	2.2	1.2	1.5	0.35	1.0	0.2	0.079	0.087	0.047	0.059	0.014	0.039	0.008
SMD0805P035TF	2	2.2	1.2	1.5	0.35	1.0	0.2	0.079	0.087	0.047	0.059	0.014	0.039	0.008
SMD0805P035TF/12	2	2.2	1.2	1.5	0.35	1.0	0.2	0.079	0.087	0.047	0.059	0.014	0.039	0.008
SMD0805P050TF	2	2.2	1.2	1.5	0.30	1.1	0.2	0.079	0.087	0.047	0.059	0.012	0.043	0.008
SMD0805P050TF/12	2	2.2	1.2	1.5	0.30	1.1	0.2	0.079	0.087	0.047	0.059	0.012	0.043	0.008
SMD0805P050TF/16	2	2.2	1.2	1.5	0.5	1.1	0.2	0.079	0.087	0.047	0.059	0.02	0.043	0.008
SMD0805P050TF/24	2	2.2	1.2	1.5	0.5	1.1	0.2	0.079	0.087	0.047	0.059	0.02	0.043	0.008
SMD0805P075TF	2	2.2	1.2	1.5	0.4	1.3	0.2	0.079	0.087	0.047	0.059	0.016	0.051	0.008
SMD0805P075TF/12	2	2.2	1.2	1.5	0.4	1.3	0.2	0.079	0.087	0.047	0.059	0.016	0.051	0.008
SMD0805P100TF	2	2.2	1.2	1.5	0.5	1.3	0.2	0.079	0.087	0.047	0.059	0.02	0.051	0.008
SMD0805P100TF/12	2	2.2	1.2	1.5	0.5	1.3	0.2	0.079	0.087	0.047	0.059	0.02	0.051	0.008
SMD0805P110TF	2	2.2	1.2	1.5	0.5	1.3	0.2	0.079	0.087	0.047	0.059	0.02	0.051	0.008
SMD0805P110TF/12	2	2.2	1.2	1.5	0.5	1.3	0.2	0.079	0.087	0.047	0.059	0.02	0.051	0.008
SMD0805P125TF	2	2.2	1.2	1.5	1.0	1.5	0.2	0.079	0.087	0.047	0.059	0.039	0.059	0.008
SMD0805P150TF	2	2.2	1.2	1.5	1.0	1.5	0.2	0.079	0.087	0.047	0.059	0.039	0.059	0.008



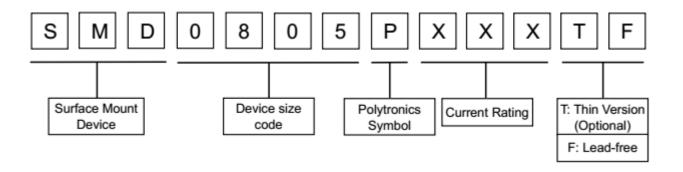
Taping and Reel Specifications



Symbol	Millimeters	Inches
w	8±0.3	0.315±0.012
Р	4±0.1	0.157±0.004
P0	4±0.1	0.157±0.004
P2	2±0.05	0.079±0.002
F	3.5±0.05	0.138±0.002
E	1.75±0.1	0.069±0.004
D	1.55±0.05	0.061±0.002
D1(max)	178	7.007
D2(min)	60	2.362
W1	9.0±0.5	0.354±0.02



Part Number Code



Environmental Specifications

Conditions	Test
+85℃,1000 hrs	Passive aging
+85℃, 85%R.H.,168 hours	Humidity aging
+85℃ to -40℃, 20times	Thermal shock
MIL-STD-202, Method 215	Resistance to solvent
MIL-STD-202, Method 201	Vibration
	Vibration Ambient operating conditions : - 40°C to +85°C
	+85℃,1000 hrs +85℃, 85%R.H.,168 hours +85℃ to -40℃, 20times MIL-STD-202, Method 215 MIL-STD-202, Method 201

Maximum surface temperature of the device in the tripped state is 125 °C

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